(max) output to the module.

temperature.



General Description

The MAX1978 evaluation kit (EV kit) is a fully assembled

and tested PC board that implements a complete

switch-mode temperature control system for a Peltier

thermo-electric cooler (TEC) module. It operates from a single 3V to 5.5V supply and provides a bipolar $\pm 2.2A$

A potentiometer, DAC, or external source generates a

DC temperature set-point voltage. Thermal feedback

from the TEC module is compared to the set-point voltage to generate the TEC current control signal. The

MAX1978 controls TEC current to accurately regulate

When using the DAC, the EV kit connects to the parallel

port of a computer running Windows® 95, 98, or 2000.

____Features

- Circuit Footprint Less than 0.93in²
- Circuit Height Less than 3mm
- Operates from a Single Supply (3V to 5.5V)
- ±2.2A Output Current
- High-Efficiency Switch-Mode Design
- Programmable Heating/Cooling Current Limit
- TEC Current Monitor Output
- Overtemperature, Undertemperature, and Analog Temperature Monitor
- 500kHz or 1MHz Switching Frequency
- ◆ SPI[™]-Compatible Serial Interface
- Easy-to-Use Menu-Driven Software
- Includes Windows 95-/98-/2000-Compatible Software and Demo PC Board
- ♦ Surface-Mount Construction
- Fully Assembled and Tested

Ordering Information

PART	TEMP RANGE	IC PACKAGE
MAX1978EVKIT	0°C to +70°C	48 Thin QFN (7mm × 7mm)

SPI is a trademark of Motorola, Inc. Windows is a registered trademark of Microsoft Corp.

DESIGNATION	QTY	DESCRIPTION
C1	1	4.7μF, 6.3V X5R, ceramic capacitor (0805) Murata GRM21BR60J475M Taiyo Yuden JMK212BJ475MG TDK C2012X5R0J475M
C2, C7, C12, C17	4	1µF, 6.3V X5R ceramic capacitors (0603) Murata GRM188R60J105M Taiyo Yuden JMK107BJ105MA TDK C1608X5R1A105K
C3, C6, C9, C11	4	10μF, 6.3V X5R ceramic capacitors (0805) Murata GRM21BR60J106K Taiyo Yuden JMK212BJ106MG TDK C2012X5R0J106M
C4	1	0.01µF, 16V X7R ceramic capacitor (0402) Murata GRP155R71C103K Taiyo Yuden EMK105BJ103KV TDK C1005X7R1E103K

<u>Component List</u>

DESIGNATION	QTY	DESCRIPTION
C5	0	Not installed (0402)
C8	1	0.47µF, 6.3V X7R ceramic capacitor (0603) Murata GRM188R60J474K Taiyo Yuden LMK107BJ474KA TDK C1608X5R1A474K
C10	1	0.047µF, 10V X7R ceramic capacitor (0402) Murata GRP155R71A473K Taiyo Yuden LMK105BJ473KV TDK C1005X7R1C473K
C16, C21	0	Not installed (0603)
C19	1	22μF, 6.3V X5R ceramic capacitor (1210) Murata GRM32DR60J226K Taiyo Yuden JMK325BJ226MM TDK C3225X5R0J226M

Component List continued on next page.

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For pricing, delivery, and ordering information, please contact Maxim/Dallas Direct! at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

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DESIGNATION	QTY	DESCRIPTION
C20	0	Not installed (1210)
JU1, JU3, JU4	3	3-pin headers
JU2	1	2-pin header
L1, L2	2	3µH, 2.4A inductors Sumida CDRH5D28-3R0NC
R1	1	0.068Ω ±1%, 0.5W sense resistor (1206) IRC LRC-LR1206-01-R068-F
R2	1	49.9k Ω ±1% resistor (0402)
R3	1	100k Ω ±1% resistor (0402)
R4–R8	0	Not installed (0402)
R9	1	80.6k Ω ±1% resistor (0603)
R10	1	69.8k Ω ±1% resistor (0603)
R11	1	105k Ω ±1% resistor (0603)
R12	1	20k Ω ±1% resistor (0603)
R13	1	$10k\Omega$ temp coefficient = 25ppm/°C, 0.1% resistor (0805)
R14	1	$1M\Omega \pm 5\%$ resistor (0402)
R15	1	20k Ω ±5% resistor (0402)
R16	1	100k Ω ±5% resistor (0402)
R25, R26	2	100k Ω ±5% resistors (0603)

Component List (continued)

DESIGNATION	QTY	DESCRIPTION
SW1	1	Switch, momentary, normally open
U1	1	MAX1978ETM 48-pin thin QFN-EP*
None	4	Shunts
DAC AND INTER	-	COMPONENTS. REQUIRED ONLY
C13, C14, C15	3	0.1µF, 16V X7R ceramic capacitors (0603) Murata GRM188R71C104K Taiyo Yuden EMK107BJ104KA TDK C1608X7R1C104K
C18	0	Not installed (0603)
J1	1	DB25 male right-angle connector
Q1, Q2, Q3	3	NPN bipolar transistors, SOT23 Central Semiconductor CMPT3904 Diodes Inc. MMBT3904 Fairchild MMBT3904 General Semiconductor MMBT3904
R17, R18, R19, R23	4	1k Ω ±5% resistors (0603)
R20, R21, R22	3	4.7k Ω ±5% resistors (0603)
R24	1	20k Ω potentiometer (multiturn)
U2	1	MAX5144EUB 10-pin µMAX

*EP = Exposed pad.

Component Suppliers

SUPPLIER	PHONE	FAX	WEBSITE
Central Semiconductor	631-435-1110	631-435-1824	www.centralsemi.com
Diodes Inc.	805-446-4800	805-381-3899	www.diodes.com
Fairchild	888-522-5372	—	www.fairchildsemi.com
General Semiconductor	760-804-9258	760-804-9259	www.gensemi.com
International Rectifier Co. (IRC)	361-992-7900	361-992-3377	www.irctt.com
Murata	770-436-1300	770-436-3030	www.murata.com
Sumida	847-545-6700	847-545-6720	www.sumida.com
Taiyo Yuden	800-348-2496	847-925-0899	www.t-yuden.com
TDK	847-803-6100	847-390-4405	www.component.tdk.com

Note: Please indicate you are using the MAX1978 when contacting these manufacturers.

__Quick Start

Required Equipment

The following equipment is required before beginning:

- One DC power supply capable of supplying any voltage between 3V and 5.5V at 3A
- One Peltier TEC module with a thermistor (NTC 10k Ω at +25°C)
- One digital voltmeter (DVM)



Procedure

The MAX1978 EV kit is a fully assembled and tested surface-mount board. Follow the steps below to verify board operation. **Do not turn on the power supply until all connections are completed:**

- 1) Place a shunt across pins 2-3 on JU1 to set the frequency to 500kHz.
- 2) Place a shunt across JU2 to connect the thermal loop to CTLI.
- 3) Place a shunt across pins 2-3 on JU4 to select the potentiometer.
- 4) Place a shunt across pins 2-3 on JU3 to disable the MAX1978 output.
- 5) Obtain TEC module specifications for absolute maximum TEC voltage, absolute maximum cooling current, and absolute maximum heating current. Set these (or lower) limits at the MAX1978's MAXV, MAXIP (heating current), MAXIN (cooling current) inputs. See Tables 1, 2, and 3 to select resistors, or refer to the MAX1978 data sheet.
- 6) Connect the TEC module to OS1, OS2, THERM, and GND. Typical connections for most modules:
 - Module TEC+ to OS1
 - Module TEC- to OS2
 - Module thermistor to THERM
 - Second module thermistor pin to GND
 - Module case ground or shield to GND

Check module specifications before making connections. For lowest noise, connect the thermistor through shielded wire.

- 7) Connect the DVM to SET_POINT and GND.
- 8) Connect a 3.3V DC or 5V DC power supply with sufficient power rating to VDD and GND.
- 9) Turn on the power supply.

Note: The MAX1978 output is not enabled yet.

- 10) Adjust R24 until the DVM reads 0.75V. This adjusts the set point for approximately +25°C.
- Move the DVM positive lead to THERM and verify a voltage of approximately 0.75V. This corresponds to an ambient temperature of +25°C at the TEC module.
- 12) Enable the MAX1978 by moving the shunt on JU3 to the 1-2 position.
- 13) After enabling the MAX1978, verify that the THERM voltage converges toward the set-point voltage on R24 (set to 0.75V in Step 9) after approximately 30s. If the TEC is connected backward, the

THERM voltage moves away from 0.75V toward either 0V or 1.5V. If this occurs, shut down the MAX1978 and reverse TEC+ and TEC- connections.

14) Once proper operation is verified, other temperatures can be set with R24, the DAC, or an external voltage applied to SET_POINT. (1V is approximately +10°C; 0.5V is approximately +40°C. The slope is approximately -14mV/°C for a typical NTC.)

_Detailed Description

Voltage and Current-Limit Settings

The MAX1978 provides control of the maximum differential TEC voltage and the maximum positive and negative TEC currents.

The voltage on the MAXV pin of the MAX1978 sets the maximum differential TEC voltage. Use the following equations to set the voltage:

Voltage on MAXV:
$$V_{MAXV}(V) = REF \times \frac{R3}{R2+R3}$$

Maximum TEC voltage: VTEC(MAX) = 4 × VMAXV

The components installed on the MAX1978 EV kit set V_{MAXV} to 1V, for a maximum TEC voltage of 4V. See Table 1 and refer to the MAX1978 data sheet for more information.

Table 1. Maximum TEC Voltage

VTEC(MAX) (V)	R2 (k Ω)	R3 (k Ω)
4	49.9	100
2.6	130	100

The voltages on the MAXIP and MAXIN pins set the maximum positive (heating) and negative (cooling) currents through the TEC. Use the following equations to set the currents:

Voltage on MAXIP:
$$V_{MAXIP}(V) = REF \times \frac{R7}{R6 + R7}$$

Voltage on MAXIN:
$$V_{MAXIN}(V) = REF \times \frac{R5}{R4 + R5}$$

Resistor values for R2 through R7 should be between 10k Ω and 100k $\Omega.$

Maximum positive TEC current:

$$I_{\text{TECP}(\text{MAX})}(A) = + \frac{V_{\text{MAXIP}}}{10 \times R_{\text{SENSE}}}$$

where RSENSE (R1) is $68m\Omega$.

Maximum negative TEC current:

Evaluates: MAX1978

$$I_{\text{TECN(MAX)}}(A) = -\frac{V_{\text{MAXIN}}}{10 \times R_{\text{SENSE}}}$$

The components installed on the MAX1978 EV kit set the maximum positive current to +2.2A and the maximum negative current to -2.2A. See Tables 2 and 3, and refer to the MAX1978 data sheet for more information.

Table 2. Maximum Positive TEC Current

ITECP(MAX) (A)	R6 (k Ω)	R7 (k Ω)
2.2	Short	Open
1.1	100	100
0.7	100	49.9

Table 3. Maximum Negative TEC Current

ITECN(MAX) (A)	R4 (k Ω)	R5 (k Ω)
2.2	Short	Open
1.1	100	100
0.7	100	49.9

Jumper JU1

Jumper JU1 sets the switching frequency for the MAX1978. Position 1-2 sets the frequency to 1MHz. Position 2-3 sets it to 500kHz.

Jumper JU2

Jumper JU2 connects the current-control input (CTLI) of the MAX1978 to the thermal-loop circuit. The thermal-loop circuit compares thermistor feedback from the TEC module to the set-point voltage to generate the CTLI signal.

To drive CTLI directly, remove the shunt on JU2 and apply a DC voltage between 0 and 3V to the CTLI pad; 1.5V on CTLI sets a TEC current of approximately 0A. A voltage of 0V or 3V on CTLI produces -2.2A or +2.2A,

Table 4. Jumper Selection

respectively. The current changes proportionally with the voltage applied to CTLI.

Note: The current does not reach $\pm 2.2A$ if the maximum positive and negative current limits are set to lower values. See the Voltage and Current-Limit Settings section and refer to the MAX1978 data sheet for more information.

Jumper JU3

The MAX1978 can be placed in shutdown mode using jumper JU3. See Table 4 for jumper settings.

Jumper JU4

Jumper JU4, position 1-2, connects the DAC to the thermal-loop circuit. Connect the EV kit to the parallel port of a computer and use the EV kit software to control the DAC. Position 2-3 connects potentiometer R24 to the thermal-loop circuit. To use an external voltage to control the thermal loop, remove the shunt from JU4 and apply the voltage to the SET_POINT pad. A voltage of 0.75V corresponds to approximately +25°C. 1V is approximately +10°C, and 0.5V is approximately +40°C. The slope is approximately -14mV/°C for a typical NTC.

Switch SW1

Switch SW1 resets the DAC to 0.75V.

ITEC Current Monitor Output

The ITEC output provides a voltage proportional to the actual TEC current. V_{ITEC} = REF when TEC current is zero. The actual TEC current is:

$$I_{\text{TEC}} = \frac{V_{\text{TEC}} - 1.5V}{8 \times \text{R1}}$$

Use ITEC to monitor the cooling or heating current through the TEC module. Positive values of I_{TEC} indicate heating for typically connected modules. The maximum capacitance that ITEC can drive is 100pF.

JUMPER	JUMPER POSITION	FUNCTION	
JU1	1-2	MAX1978 switching frequency is 1MHz.	
JU I	2-3*	MAX1978 switching frequency is 500kHz.	
	Open	Drive the CTLI pad directly with a DC voltage. Disconnects the thermal-loop circuit.	
JU2 Closed* Thermal-control loop is closed. DAC or R24 generates temperature s		Thermal-control loop is closed. DAC or R24 generates temperature set point.	
	1-2	SHDN = high, MAX1978 enabled.	
JU3	2-3*	SHDN = low, MAX1978 disabled.	
	1-2 DAC generates temperature set point.		
JU4	2-3*	Potentiometer R24 generates temperature set point.	
Open		Voltage applied to SET_POINT generates temperature set point.	

*Default position

Controlling DAC Through Parallel Port

Required Equipment

In addition to the equipment listed under the *Quick Start* section, the the following equipment is required:

- A computer running Windows 95, 98, or 2000.
 Note: Windows 2000 requires the installation of a dri-
- ver; refer to Win2000.pdf or Win2000.txt located on the diskette.
- A parallel printer port (25-pin socket on the back of the computer)
- A standard 25-pin, straight-through, male-to-female cable (printer extension cable) to connect the computer's parallel port to the MAX1978 EV kit

Procedure

- 1) Place a shunt across pins 2-3 on JU1 to set the frequency to 500kHz.
- 2) Place a shunt across JU2 to connect the thermal loop to CTLI.
- Place a shunt across pins 1-2 on JU4 to select the DAC.
- 4) Place a shunt across pins 2-3 on JU3 to disable the MAX1978 output.
- 5) Obtain TEC module specifications for absolute maximum TEC voltage, absolute maximum cooling current, and absolute maximum heating current. Set these (or lower) limits at the MAX1978's MAXV, MAXIP (heating current), MAXIN (cooling current) inputs. See Tables 1, 2, and 3 to select resistors, or refer to the MAX1978 data sheet.
- 6) Connect the TEC module to OS1, OS2, THERM, and GND. Typical connections for most modules:
 - Module TEC+ to OS1
 - Module TEC- to OS2
 - Module thermistor to THERM
 - Second module thermistor pin to GND
 - Module case ground or shield to GND

Check module specifications before making connections. For lowest noise, connect the thermistor through shielded wire.

7) Connect a cable from the computer's parallel port to the MAX1978 EV kit. Use a straight-through 25pin female-to-male cable. To avoid damaging the EV kit or your computer, do not use a 25-pin SCSI port or any other connector that is physically similar to the 25-pin parallel printer port.

- 8) The MAX1978.EXE software program can be run from the floppy or hard drive. Use the Windows program manager to run the program. If desired, you can use the INSTALL.EXE program to copy the files and create icons for them in the Windows 95/98/2000 start menu. An uninstall program is included with the software. Click on the UNINSTALL icon to remove the EV kit software from the hard drive.
- Connect a 3.3V DC or 5.0V DC power supply with sufficient power rating to VDD and GND.
- 10) Turn on the power supply.
- Start the MAX1978 program by opening its icon in the start menu. At program startup, the software forces the DAC to 0.75V, which corresponds to approximately +25°C.
- 12) Connect the DVM to THERM and verify a voltage of approximately 0.75V. This represents +25°C at the TEC module.
- 13) Enable the MAX1978 by moving the shunt on JU3 to the 1-2 position.
- 14) After enabling the MAX1978, verify that the THERM voltage converges toward the DAC voltage (0.75V) after approximately 30s. If the TEC is connected backward, the THERM voltage moves away from 0.75V toward either 0V or 1.5V. If this occurs, shut down the MAX1978 and reverse TEC+ and TEC-connections.
- 15) Once proper operation is verified, other temperatures can be set with the DAC (see the *Software User Interface* section).

Software User Interface

The user interface is easy to operate. Use either the mouse or the Tab key to navigate.

To program the DAC, enter the ratio of the desired DAC output voltage (V_{DAC}) to the reference voltage (REF):

Ratio =
$$\left(\frac{V_{DAC}}{REF}\right)$$

where REF = 1.5V.

The ratio must be a decimal number between zero and 1. Press Enter or click on the Update button to send the data to the DAC.

M/XX/M

The program starts with ratio = 0.5. This sets the DAC output to 0.75V, which corresponds to $+25^{\circ}C$.

A ratio of 0.67 sets the DAC output to 1V, which corresponds to approximately $+10^{\circ}$ C. A ratio of 0.33 sets the DAC output to 0.5V, or approximately $+40^{\circ}$ C. The slope is approximately -14mV/°C for a typical NTC.

General-Purpose SPI Utility

There are two methods for communicating with the MAX5144 DAC: through the user-interface panel or through the general-purpose SPI utility. This utility (Figure 3) configures SPI parameters such as clock polarity (CPOL), clock phase (CPHA), and chip-select (CS) polarity. The fields where pin numbers are required apply to the pins of the parallel port connector.

The utility handles the data only in byte (8-bit) format. Data longer than a byte must be handled as multiple bytes. For example, a 16-bit word must be broken into two 8-bit bytes. To write data to the slave device, enter the data into the field labeled "Data bytes to be written:" Each data byte should be hexadecimal, prefixed by 0x, and separated with a comma. Press the Send Now button to write the data to the slave.

To read data from the slave device, the field "Data bytes to be written:" must contain hexadecimal values. Include the same number of bytes as to be read from the slave.

Note: The MAX5144 is a write-only device and cannot be read.

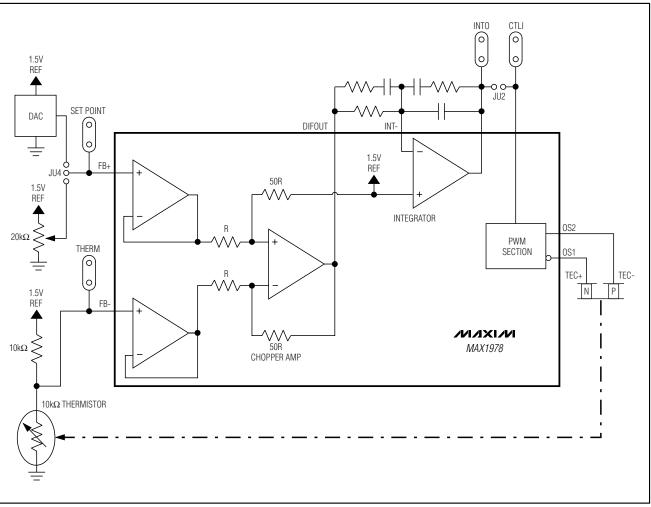


Figure 1. Thermal-Loop Functional Diagram for the MAX1978 EV Kit

MAX1978 Power Driver for Peltier Modules				
SPI hardware found.				
Ratio of DAC output voltage to REF				
0.50000 Update				
DAC Code: 0x2000				
Data Sent: 10000000 0000000, 0x8000				
<u>S</u> PI Utility <u>A</u> bout <u>? H</u> elp E <u>x</u> it				

Evaluates: MAX1978

Figure 2. Main Window for the MAX1978 EV Kit

🕌 Parallel Port Diagnostic (maxlpt.dll) 🛛 📃 🔍				
Port Pins Bit-Banging Serial Interface Logging				
Connection SCK clock output pin: CS output pin: MOSI data output pin: MISO data input pin: 11	Configuration CPOL=1 (clock idles high) CPHA=1 (samp 2nd edge) CS active high, idle low CS active high, idle low CS active high, idle low Data Output Inverted Logic Data Input Inverted Logic 0.500 ▼ kHz clock rate 8 ÷ bits per byte Send & receive MSB first			
Send and Receive Data				
Data bytes to be written:				
0x80, 0x00				
Send Now repeat 1 ÷				
Data bytes received:				
{2 bytes:0x80,0x00}				

Figure 3. SPI Utility Showing the Settings to Communicate with the MAX1978 EV Kit

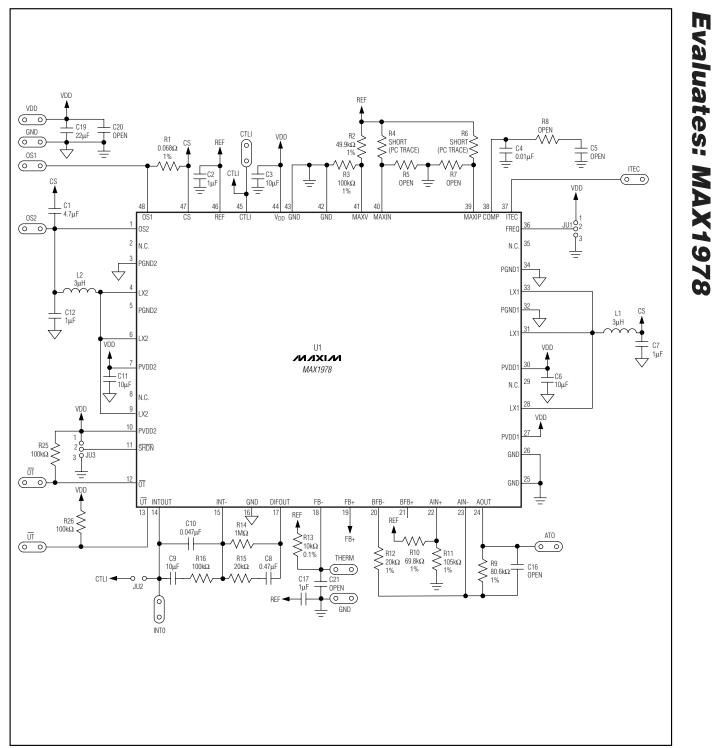


Figure 4. MAX1978 EV Kit Schematic (Sheet 1 of 2)

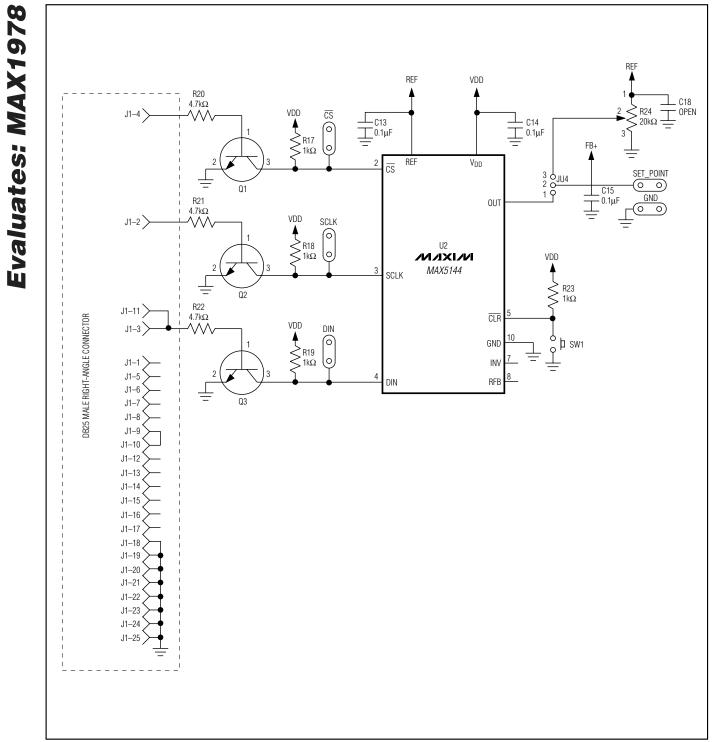


Figure 5. MAX1978 EV Kit Schematic (Sheet 2 of 2)

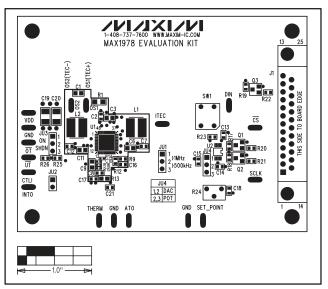


Figure 6. MAX1978 EV Kit Component Placement Guide— Component Side

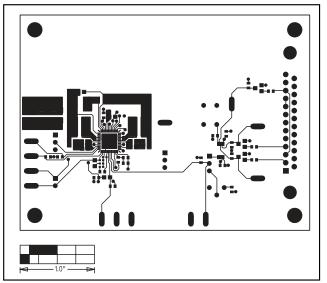


Figure 7. MAX1978 EV Kit PC Board Layout (2oz Copper)— Component Side

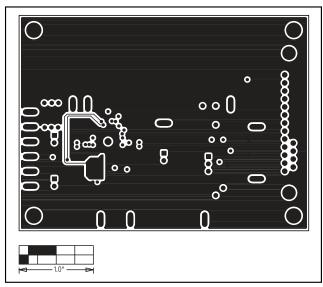


Figure 8. MAX1978 EV Kit PC Board Layout (2oz Copper)— Ground Plane

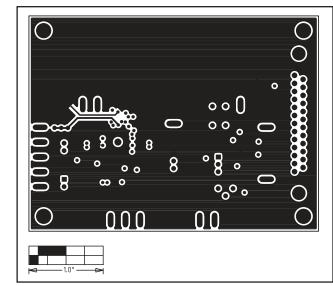


Figure 9. MAX1978 EV Kit PC Board Layout (2oz Copper)— Power Plane

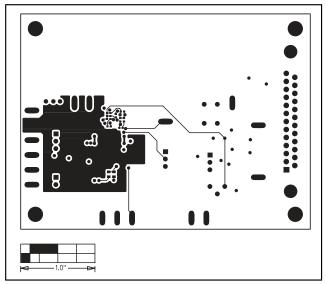


Figure 10. MAX1978 EV Kit PC Board Layout (2oz Copper)— Solder Side

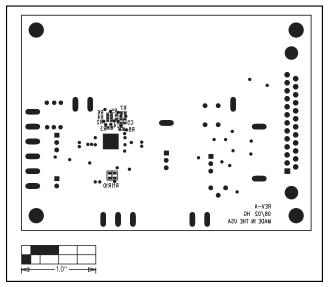


Figure 11. MAX1978 EV Kit Component Placement Guide (2oz Copper)—Solder Side

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